DS2715 SEMICONDUCTOR VICTOR VICTOR VICTOR

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DESCRIPTION

The DS2715 is well suited for cost-sensitive charger applications where the battery pack is either internal or external to the application. It has been optimized for safe reliable charging of 1 to 10 NiMH cells in series. The DS2715 has an internal gain block that can be selected as either a comparator or transconductance amplifier for charge current regulation. The DS2715 is configurable as a switched DC charger, a linear current regulator, or a switchmode current source. The DS2715 pre-conditions severely depleted cells before entering full charge mode. The DS2715 terminates full charge using the dT/dt technique. It requires an external thermistor for dT/dt detection. Over-temperature, under-temperature, and overvoltage detection prevents charging under unsafe conditions. A user selectable charge timer allows charge rates from 0.15C to 2C. Fast-charge, Top-off and Done modes are included for highly reliable, safe charging of NiMH cells. Discharge mode allows the DS2715 to enter a low power sleep state while the cell pack is being discharged.

FEATURES

- Charges 1 to 10 NiMH Cells
- Fast Charges up to a 2C Rate
- Pre-Charge and Top-Off Charge Modes Help Cell Conditioning
- Load Detection Allows the DS2715 to Enter Low Power Sleep Mode (Less than 10µA) while the Cell Pack is Discharged
- dT/dt Charge Termination Eliminates Cell Charge Stress
- Monitors Voltage, Temperature, and Time for Safety and Secondary Termination
- Regulates Current through Either Linear Control or Switch-Mode Control
- LED Output Display Charge State
- Small 16-Pin SO Package

APPLICATIONS

Portable DVD Players Portable Television Sets Handheld Gaming Test Equipment Handheld POS Terminals

PIN CONFIGURATION



Table 1. ORDERING INFORMATION

PART	MARKING	PIN-PACKAGE
DS2715Z+	DS2715+	16 SO
DS2715Z+T&R	DS2715+	16 SO Tape-and-Reel

+ Denotes lead-free package.

OPERATIONAL DIAGRAM



Note: Some revisions of this device may incorporate deviations from published specifications known as errata. Multiple revisions of any device may be simultaneously available through various sales channels. For information about device errata, click here: <u>www.maxim-ic.com/errata</u>.

ABSOLUTE MAXIMUM RATINGS*

Voltage on V_{DD} and V_{CH} Pins with Respect to V_{SS} Voltage on LED1 Pin Voltage on SNS-Voltage on all Other Pins Continuous Sink Current V_{CH} and LED1 Operating Temperature Range Storage Temperature Range Soldering Temperature Human Body Model (HBM) ESD Limit of V_{CH} Pin HBM ESD Limit of all Other Pins -0.3V to +18V -0.3V to +18V -0.3V to +0.3V -0.3V to 6V -0.3V to V_{Cbias} 28mA -20°C to +85°C -55°C to +125°C See IPC/JEDECJ-STD-020 500V 2KV

*This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS

			(4.5V ≤	$V_{DD} \le 16.5V$	'; T _A = 0°0	C to +70°C.)
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V_{DD}	(Note 1)	4.5		16.5	V
LED1 Voltage	V_{LED}	(Note 1)	0.0		16.5	V
Mode Voltage	V _{MODE}	(Note 1)	0.0		V_{Cbias}	V
V _{CH} Voltage	V _{VCH}	(Note 1)	0.0		16.5	V
C _{BIAS} Capacitor Range	C_{Cbias}		.02		.15	μF
R_T Resistor Range	R _{Rt}		20		240	KΩ

DC ELECTRICAL CHARACTERISTICS

	$(4.5V \le V_{DD} \le 16.5V, T_A = 0^{\circ}C \text{ to } +70^{\circ}C, \text{ unless otherwise noted.})$								
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS			
Operating Current	_	Linear Mode, V_{DD} = 16.5V		1.3	1.6	mA			
(Note 2)	I _{DDA}	Comparator Mode, V_{DD} = 16.5V		150	250	μA			
Idle Current	I _{DDS}	$V_{DD} < V_{UVLO}$			10	μA			
Discharge Current	I _{DDD}	Discharge latch set (Note 2)			200	μA			
UVLO Threshold	V _{UVLO}	V _{DD} Rising (Note 3)	3.8	3.9	4.0	V			
UVLO Hysteresis	JVLO Hysteresis V _{UVLO-HYS}			35		mV			
V _{CH} Sink Current	I _{OL-Vch}	V _{OL} = 1.5V	20			mA			
LED1 Sink Current	I _{OL-LED}	V _{OL} = 1.0V	20			mA			
Leakage Current, V _{CH} , LED1	I _{LKG}	Pin Inactive or Device Idle	-1		+1	μA			
THM Pin Leakage Current	I _{LKG-THM}		-1		+1	μA			
V _{BATT} Pin Leakage Current	I _{LKG-Vbatt}		-50		+50	nA			
C _{BIAS} Voltage	V _{Cbias}	$0 < I_{Cbias} < 0.4 mA$	3.9	4.0	4.3	V			
DIV Pin Load Current	I _{Div}				500	uA			
Current Sense Amplifier Gain	G _{ERR}	100µA < I _{Vch} < 20mA	5	6.25	7.5	$\tilde{\Omega^{-1}}$			

DS2715: NiMH Battery Pack Charge Controller

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Current Sense Comparator Gain	G _{COMP}	(Note 7)	10			$\tilde{\Omega^{-1}}$

AC ELECTRICAL CHARACTERISTICS

$(4.5V \le V_{DD} \le 16.5V, T_A = 0^{\circ}C \text{ to } +70^{\circ}C, \text{ unless otherwise not}$						
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
UVLO Debounce Time	t _{UVLO}		10			μs
Current Sense Comparator Propagation Delay	t _{COMP}	(Note 7)			250	ns
Discharge Detect Propagation Delay	t _{DD}	From detection of current reversal			1	μs
Return To Normal Function (Op-Amp or Comparator Mode)	t _{RNF}	Time from reset of discharge latch			1	μs
R_T Timing Accuracy	t _{Rt}	(Note 4)	-10		+10	%
Internal Clock Accuracy	t _{BASE}		-10		+10	%

ELECTRICAL CHARACTERISTICS: CHARGING

		$(4.5V \le V_{DD} \le 16.5V, T_{DD} \le 16.5V)$	$_{A} = 0^{\circ}C$ to	+70°C, u	nless other	wise noted.)
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Fast Charge Comparator Threshold	V_{FC}	Fast charge	-127	-121	-115	mV
Fast Charge Comparator Hysteresis	$V_{\text{HYS-FC}}$	Fast charge	-31	-28	-25	mV
Top-off and Pre-Charge Comparator Threshold	V _{TO}	Top-off and pre-charge	-38	-33	-28	mV
Top-off and Pre-Charge Comparator Hysteresis	V _{HYS-TO}	Top-off and pre-charge	-10	-8	-6	mV
Discharge Latch Reset Threshold	V _{DCHG-RST}		-15	-10	-5	mV
Discharge Latch Set Threshold	V _{DCHG-SET}	Reverse current through sense resistor	5	10	15	mV
Low Battery Detect Threshold	V _{LB}	From presence detect into pre-charge	0.95	1.0	1.05	V
Cell Detect Threshold	V _{DET}		1.50	1.55	1.60	V
No Cell Detect Threshold	V _{OPEN}		1.60	1.65	1.70	V
Presence Detect Threshold Hysteresis	V _{HYS-PD}		90	100	110	mV
Minimum Charge Tomp	V	(Noto E. C)	2.88	2.92	2.96	V
Minimum Charge Temp	V _{THM-MIN}	(Note 5, 6)		0		°C
Maximum Charge Temp	V	(Note 5, 6)	1.28	1.32	1.36	V
Maximum Charge remp	V _{THM-MAX}			45		°C
Over Temp	V _{THM-STOP}	(Note 5, 6)	1.12	1.16	1.20	V
	* THM-STOP			50		°C
dT/dt Detect	T _{TERM}		0.425	0.5	0.575	°C/min
dT/dt Blanking Time	t _{BLANK}		3.85	4.3	4.75	Min

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Fast Charge Timer Range	t _{FC}		0.5		6	Hours
Top-Off to Fast Charge Duration Ratio				1:2		

Note 1:

Voltages relative to V_{SS} . Does not include current through V_{CH} , R_T , and DIV pins. Below this voltage no I/O pins are active. Does not include tolerance of R_T resistor. Note 2:

Note 3:

Note 4:

 V_{BIAS} and resistor tolerances must be added to determine actual threshold. Note 5:

Note 6: Specified temperature thresholds are only valid if recommended thermistor types are used.

Note 7: Specification is guaranteed by design.

DETAILED PIN DESCRIPTION

PIN	NAME	DESCRIPTION
1	C _{BIAS}	Bypass for Internal Voltage Regulator
2	V _{CH}	Cell Stack Charge Control Output
3	V _{SS}	Ground Reference and Chip Supply Return
4	LED1	Charging Indicator Output
5	DNC	Do Not Connect
6	V _{SS}	Ground Reference and Chip Supply Return
7	CTG	Connect to Ground
8	CTG	Connect to Ground
9	MODE	Mode Select. Connect to V_{SS} for linear mode of operation or C_{BIAS} for comparator mode of operation.
10	DIV	Thermistor Divider. Stable output to form a resistor divider for measuring temperature on THM
11	SNS+	Positive Current Sense. Connect to the pack side of the sense resistor
12	SNS-	Negative Current Sense. Connect to the cell stack side of the sense resistor
13	V _{DD}	Chip Supply Input: +4.0V to +5.5V range
14	R⊤	Failsafe Timeout. Timeout is selected by an external resistor from R_T to V_{SS}
15	THM	Thermistor Input. Connect to a thermistor located in the cell pack and a divider resistor from the Div pin
16	V _{BATT}	Battery Voltage Sense Input. Connect to a divider from the positive terminal of the cell stack to measure the voltage of a single cell

Figure 1. BLOCK DIAGRAM



Figure 2. STATE DIAGRAM



DETAILED DESCRIPTION

Charge Cycle Overview

The DS2715 regulates the charge of up to 10 NiMH cells in a series configuration. With the mode select pin the DS2715 can be configured to regulate either as an error amplifier in linear mode or as a comparator in switched mode. A charge cycle begins in one of two ways: with the application of power to the DS2715 with cell pack already inserted or with the detection of cell insertion after power-up.

The charge cycle begins with pre-charge qualification to prevent fast charging of deeply depleted cells or charging under extreme temperature conditions. Pre-charging is performed at a reduced rate until each cell reaches 1V. The algorithm proceeds to a fast-charge phase. Fast charging continues as long as the cell pack temperature is less than 50°C based on the THM voltage, the cell voltage as measured by the V_{BATT} pin remains below 1.65V indicating the cell pack is still present. Fast charging terminates by measuring the cell pack's thermal rate of change dT/dt. When the cell pack's thermal rate of change exceeds 0.5°C per minute the DS2715 enters top-off. The DS2715 has an internal charge timer as secondary overcharge protection if the charge is not terminated by the dT/dt method. The charge termination timer duration is user selectable from 30 minutes up to 6 hours by an external resistor on the R_T pin.

The DS2715 remains in top-off for one-half of the period of the fast charge timer duration as selected by the external resistor on R_T . After the top-off charge timer expires, the done phase continues indefinitely until the cell pack is removed from the charger or a load is attached. When a load attached to the cell pack, the DS2715 switches to discharge mode. All charge functions are disabled and the regulation FET is driven on to allow the cell pack to discharge. The LED1 indicator displays the charge status to the user.

Undervoltage Lockout (Reset)

The UVLO circuit serves as a power-up and brownout detector by monitoring V_{DD} to prevent charging until V_{DD} rises above V_{UVLO} , or when V_{DD} drops below $V_{UVLO} - V_{UVLO-HYS}$. If UVLO is active, charging is prevented, the state machine is forced to the RESET state, and all charge timers are reset. A 10µs deglitch circuit provides noise immunity. Once V_{DD} reaches an acceptable operating voltage the DS2715 enters the PRESENCE state.

Presence

The DS2715 enters the PRESENCE state whenever $V_{DD} > V_{UVLO}$ and $V_{BATT} > V_{OPEN}$ indicating that the charge source is present, but no cell is available to charge. The DS2715 will remain in the presence state until a cell is inserted into the circuit causing the voltage on V_{BATT} to fall below 1.55V (V_{DET}) and the cell temperature is inside a valid charging range between 0°C and 45°C ($T_{THM-MIN}$ and $T_{THM-MAX}$). If both these conditions are met the DS2715 will remain in the PRESENCE state until the cell temperature falls within the valid charging range.

Pre-Charge

The DS2715 enters the PRE-CHARGE state when a valid cell voltage is applied to V_{BATT} and the cell temperature as measured by the DS2715 is within the valid charging range. Pre-charge has a 4 second filter to suppress noise on V_{BATT} caused by cell insertion. The DS2715 pre-charges the cell by regulating the voltage drop across the sense resistor to -33mV (V_{TO}) in linear mode or -29mV (V_{TO} - 0.5 x V_{HYS-TO}) in comparator mode. Pre-charge will last until the cell voltage measured by V_{BATT} exceeds 1.0V ($V_{BATT} > V_{LB}$) at which time the DS2715 will enter FAST CHARGE state. If the cell voltage does not exceed V_{LB} within 30 minutes or if the cell temperature exceeds 50°C at any time during pre-charge, the DS2715 enters the FAULT state. If at any time during pre-charge the voltage on V_{BATT} exceeds 1.65V (V_{OPEN}), the DS2715 determines that the cell pack has been removed and returns to the PRESENCE state.

Fast Charge

In fast charge mode, the DS2715 regulates the voltage across the sense resistor to -121 mV (V_{FC}) in linear mode or -107 mV (V_{FC} - 0.5 x V_{HYS-FC}) in comparator mode. LED1 indicates the cell pack is being charged. During fast charge the DS2715 constantly measures the rate of change of the cell temperature (dT/dt). When the cell pack's dT/dt exceeds 0.5°C per minute (T_{TERM}) the DS2715 enters the TOP-OFF state. The DS2715 ignores changes in the cell temperature caused by charge initiation for the first 4.3 minutes (t_{BLANK}). As secondary overcharge protection, the DS2715 will terminate fast charge and enter top-off based on a time delay set by the external resistor on the R_T pin. This resistor value can set the secondary charge termination delay to anywhere from 30 minutes up to 6 hours. If the cell temperature exceeds 50°C at any time during fast charge, the DS2715 enters the

DONE state. If at any time during fast charge the voltage on V_{BATT} exceeds 1.65V (V_{OPEN}), the DS2715 determines that the cell pack has been removed and returns to the PRESENCE state.

Top-Off

In top-off mode, the DS2715 regulates the voltage across the sense resistor to -33mV (V_{TO}) in linear mode or -29mV (V_{TO} - 0.5 x V_{HYS-TO}) in comparator mode. LED1 indicates the cell pack is being charged. The charge timer is reset and restarted with a time-out period of one half the fast-charge duration. When the charge timer expires or if the measured temperature exceeds 50°C, the charger enters the DONE state.

DONE/Maintenance

The DS2715 enters the DONE state whenever the charge completes normally or if the measured cell temperature exceeds 50°C during the charge. While in the done state V_{CH} is driven to high impedance to prevent further charging of the cell pack and LED1 is driven on to indicate charge completion. A maintenance charge can be applied to the cells by providing a resistive path from the cell pack to the charge source bypassing the regulator. See the example circuit in Figure 3. The DS2715 remains in DONE until a cell voltage greater than 1.65V (V_{OPEN}) is detected on V_{BATT} indicating the cell pack has been removed. The DS2715 then enters the PRESENCE state and waits for the next cell insertion.

FAULT

The DS2715 enters FAULT if pre-charge is unable to charge the cell above 1.0V (V_{LB}) before the 30 minute precharge timeout of if the cell temperature exceeds 50°C during pre-charge. In the fault state V_{CH} is driven to high impedance and LED1 blinks to indicate the fault condition. The DS2715 remains in FAULT until a cell voltage greater than 1.65V (V_{OPEN}) is detected on V_{BATT} indicating the cell pack has been removed. The DS2715 then enters the PRESENCE state and waits for the next cell insertion.

Discharge Mode

When the DS2715 detects a discharge current voltage drop of $V_{DCHG-SET}$ or greater across the sense resistor, charging is terminated and the DS2715 enters the DISCHARGE state. While in this mode, voltage sensing, thermal sensing, and LED1 output is disabled. The V_{CH} pin is driven low to allow the pack to be discharged. Current drain of the DS2715 drops to I_{DDD}. The DS2715 remains in discharge mode until a charge current of at least $V_{DCHG-RST}$ is detected. When this occurs the DS2715 enters the presence detect state to begin a new charge cycle.

Application Circuit

Figure 3 shows a typical application circuit for charging a 3-cell stack. The mode pin is tied to V_{SS} for linear operation. A 75m Ω sense resistor (R10) sets the charge current at 1.6A. The DS2715 regulates the current through Q1. 68k Ω on R_T (R6) sets the fast charge timeout to 102 minutes. R5 and R8 form a 1:3 voltage divider to allow V_{BATT} to measure the voltage of a single cell. The charge source is isolated with diode CR1 to prevent discharge through the source connection. R1 and CR2 form a maintenance charge path to supply the cell pack with ~40mA constant current after the charge completes. Lastly VR1 and R4 create a current leakage path to bias the regulator circuit and prevent an in-rush current spike when the cell stack is connected to the powered circuit.

Figure 3. TYPICAL APPLICATION CIRCUIT FOR A 3-CELL STACK



CURRENT REGULATION

Three basic modes of charging operation are supported by the DS2715: Offline switching through an optocoupler, linear regulation, and DC input switched mode. The offline switching method requires a voltage clamp on the regulated output. Mode of operation is selected through the Mode pin. Connecting the Mode pin to V_{SS} configures the analog block as a transconductance amplifier for linear mode of operation. Connecting the Mode pin to the Cbias pin configures the DS2715 as a comparator for switched mode of operation.

Current-Sense Amplifier Mode

An error amplifier block provides several options to regulate the charge current. The 20mA open-drain output can drive a PMOS or PNP pass element for linear regulation, or the output can drive an optocoupler for isolated feedback to a primary-side PWM controller. The SNS- pin is a remote-sense return and should be connected to the grounded side of the sense resistor using a separate, insulated conductor. During fast charge, an error signal between the current-sense signal (across the sense resistor) and the internal reference is produced so the voltage across the sense resistor is maintained at V_{FC} in a closed-loop circuit. During top-off the voltage across the sense resistor is maintained at V_{TO} .

Current-Sense Comparator Mode

The comparator in the DS2715 switches between ON and OFF and is capable of driving a PNP bipolar or a PMOS transistor, enabling the use of a switched-mode power stage. Hysteresis on the comparator input provides noise rejection. In a closed-loop regulation circuit, the comparator regulates voltage across the sense resistor to a DC average of:

 $V_{RSNS} = V_{FC} - 0.5 \text{ x } V_{HYS-FC} = -0.107 \text{V}$ during fast charge $V_{RSNS} = V_{TO} - 0.5 \text{ x } V_{HYS-TO} = -0.029 \text{V}$ during top-off

Charge Rate Selection

The charge rate is determined by an external sense resistor connected between the SNS+ and SNS- pins. The DS2715 will regulate the charge current to maintain a voltage drop of V_{FC} (V_{FC} - 0.5 x V_{HYS-FC} in comparator mode) across the sense resistor during fast charge. The sense resistor can therefore be selected by:

Linear Mode: $R = V_{FC}$ / Desired Fast Charge CurrentComparator Mode: $R = (V_{FC} - 0.5 \times V_{HYS-FC})$ / Desired Fast Charge Current

Charge Time and Top-Off Time Selection

Pre-charge has a fixed 30 minute limit generated by an internal oscillator. Charge time and top-off time are controlled by an external resistor from the R_T pin to V_{SS} . Resistors can be selected to support fast-charge time-out periods of 0.5 to 6 hours and top-off charge time-out periods of 0.25 to 3 hours. If the timer expires in fast-charge, the timer count is reset and charging proceeds to the top-off charge phase. The top-off time-out period is half of the fast charge time-out period. If the timer expires in top-off, the DS2715 enters the DONE state. The programmed charge time approximately follows the equation:

TEMPERATURE SENSE

Accurate temperature sensing is needed to determine end of charge by dT/dt and to detect over temperature fault conditions. Connecting an external 10k Ω NTC thermistor between THM and V_{SS}, and a 10k Ω bias resistor between Div and THM allows the DS2715 to sense temperature. To sense the temperature of the cell pack, locate the thermistor close to the body of a cell, preferably in the middle of the cell pack. Several recommended 10k Ω thermistors are shown in Table 2.

Min, Max Temperature Compare

The voltage thresholds of the THM input ($V_{THM-MIN}$, $V_{THM-MAX}$) are set to allow charging to start if 0°C < T_{CELL} < 45°C when using the recommended 10k Ω bias and 10k Ω thermistor. If pre-charging is in progress, and the voltage on THM reaches $V_{THM-STOP}$, pre-charging stops and a fault condition is generated. If the voltage on THM reaches $V_{THM-STOP}$ during fast charge or top-off, charging stops and the DS2715 enters the DONE state. Fast charging will complete normally and top-off will begin if the voltage change on THM exceeds T_{TERM} °C per minute (dT/dt charge termination).

Table 2. THM THRESHOLDS

TUM	DATIO	THERMISTOR	TEMPERATURE (°C)			
THM THRESHOLD	RATIO OF V _{CBIAS}	RESISTANCE (Ω)	Semitec 103AT-2	Fenwal 197-103LAG-A01 173-103LAF-301		
MIN	0.73	27.04k	0°C	4°C		
MAX	0.33	4.925k	45°C	42°C		
STOP	0.29	4.085k	50°C	47°C		

Used with a 10k resistor the Semitec 103AT-2 provides about 0.9% full scale per degree sensitivity. This linearity is shown in the curve in Figure 4. The left axis is the ratio of the sensed voltage to the divider's input voltage (V_{Cbias}).

Figure 4. RATIO OF THM PIN TO CBIAS PIN OVER TEMPERATURE



LED1 Output

Open-drain output LED1 pulls low to indicate charge status. When inactive, the output is high impedance. LED1 displays the state of charge and the charge results. The LED1 pin drives low in a 1Hz, 50% duty cycle "blink" pattern to indicate cells are charging. LED1 blinks at 4Hz, 50% duty cycle to signal a charging fault has occurred. The LED1 pin remains in a high-impedance state when no cells are present or the discharge latch is set. Table 3 summarizes the LED operation for each charge condition.

Table 3. LED DISPLAY PATTERNS BASED ON CHARGE STATE

	CHARGE STATE							
	NO BATTERY CHARGING				DISCHARGE MODE			
LED1	High-Z	Blinks at 1HZ, 50% duty cycle	High-Z	Blinks at 4Hz, 50% duty cycle	High-Z			

High-Z = *High Impedance*

Package Information

For the latest package outline information, go to <u>www.maxim-ic.com/DallasPackInfo</u>.